



Т	her	mal	R	esi	sta	nce

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	R_{thJC}		1.35	K/W
junction – case				
Thermal resistance,	R_{thJA}	Footprint	65	
junction – ambient		6cm² Cu	40	

Electrical Characteristic, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol Conditions		Value			Unit
raiailletei			min.	typ.	max.	Oilit
Static Characteristic						
Collector-emitter breakdown voltage	V _{(BR)CES}	$V_{\rm GE} = 0 \text{V}, I_{\rm C} = 0.2 \text{mA}$	600	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{\rm GE} = 15 \rm V, \ I_{\rm C} = 10 \rm A$				
		<i>T</i> _j =25°C	-	1.5	2.05	
		<i>T</i> _j =175°C	-	1.8	-	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_{\rm C}$ =0.3mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.1	4.6	5.7	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μA
		<i>T</i> _j =25°C	-	-	40	
		<i>T</i> _j =175°C	-	-	1000	
Gate-emitter leakage current	I _{GES}	$V_{\text{CE}}=0\text{V}, V_{\text{GE}}=20\text{V}$	-	-	100	nA
Transconductance	g fs	$V_{CE} = 20 \text{V}, I_{C} = 10 \text{A}$	-	6	-	S
Integrated gate resistor	R _{Gint}			none		Ω

Dynamic Characteristic

	1					
Input capacitance	Ciss	$V_{CE}=25V$,	-	551	-	pF
Output capacitance	Coss	$V_{GE}=0V$,	ı	40	-	
Reverse transfer capacitance	Crss	f=1MHz	ı	17	-	
Gate charge	Q _{Gate}	$V_{\rm CC} = 480 \text{V}, I_{\rm C} = 10 \text{A}$	-	62	-	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	7	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current ¹⁾	I _{C(SC)}	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 5 \mu \text{S}$ $V_{\text{CC}} = 400 \text{V},$ $T_{\text{j}} = 25 ^{\circ} \text{C}$	-	100	-	A

Switching Characteristic, Inductive Load, at T_j =25 °C

Doromotor	Symbol Conditions		Value			Unit
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	<i>T</i> _j =25°C,	-	12	-	ns

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



IGB10N60T

TRENCHSTOP™ Series

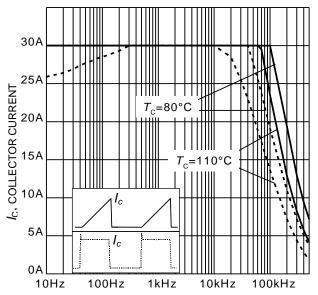
Rise time	t _r	$V_{CC}=400V, I_{C}=10A, V_{GE}=0/15V, r_{G}=23\Omega,$	-	8	-	
Turn-off delay time	$t_{d(off)}$	L_{σ} =60nH, C_{σ} =40pF	-	215	ı	
Fall time	t_{f}		-	38	-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include	-	0.16	-	mJ
Turn-off energy	E_{off}	"tail" and diode reverse	-	0.27	-	
Total switching energy	E _{ts}	recovery.	-	0.43	-	

Switching Characteristic, Inductive Load, at T_j =175 °C

Parameter	Symbol	Conditions	Value			Unit
raiametei	Symbol	Conditions	min.	typ.	max.	Oilit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_{\rm j}$ =175°C, $V_{\rm CC}$ =400V, $I_{\rm C}$ =10A, $V_{\rm GE}$ =0/15V, $I_{\rm G}$ =23 Ω , I_{σ} =60nH, I_{σ} =40pF I_{σ} , I_{σ} =60r Fig. E Energy losses include "tail" and diode reverse	-	10	-	ns
Rise time	t_{r}		-	11	-	
Turn-off delay time	$t_{d(off)}$		ı	233	-	
Fall time	t_{f}		ı	63	-	
Turn-on energy	Eon		-	0.26	-	mJ
Turn-off energy	E_{off}		1	0.35	-	
Total switching energy	Ets	recovery.	-	0.61	-	

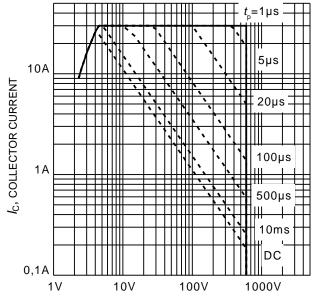






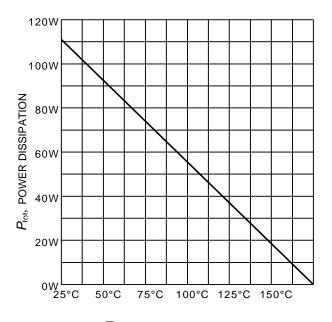
f, SWITCHING FREQUENCY

Figure 1. Collector current as a function of switching frequency $(T_j \le 175^{\circ}\text{C}, D = 0.5, V_{\text{CE}} = 400\text{V}, V_{\text{GE}} = 0/15\text{V}, r_{\text{G}} = 23\Omega)$



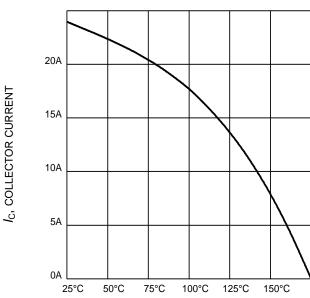
 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area $(D=0, T_C=25^{\circ}\text{C}, T_j \le 175^{\circ}\text{C}; V_{GE}=0/15\text{V})$



 $$T_{\rm C}$, CASE TEMPERATURE $$ Figure 3. Power dissipation as a function$

of case temperature $(T_i \le 175^{\circ}C)$



 $T_{\rm C}$, case temperature

Figure 4. Collector current as a function of case temperature

 $(V_{GE} \ge 15V, T_i \le 175^{\circ}C)$





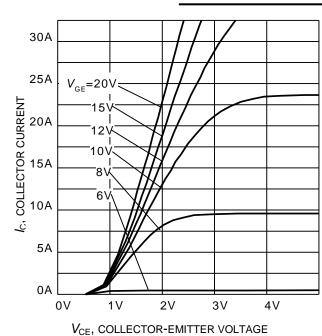


Figure 5. Typical output characteristic $(T_i = 25^{\circ}\text{C})$

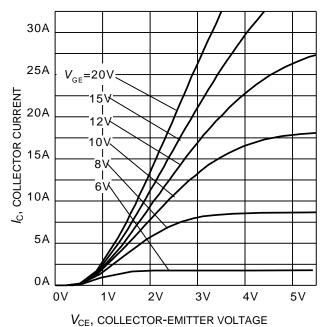


Figure 6. Typical output characteristic $(T_i = 175^{\circ}\text{C})$

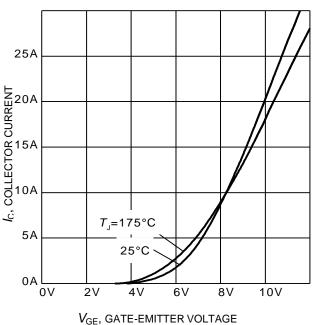
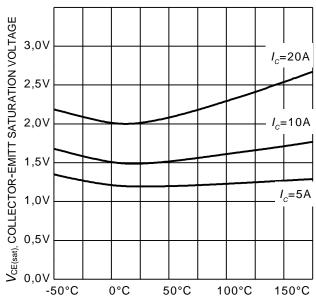


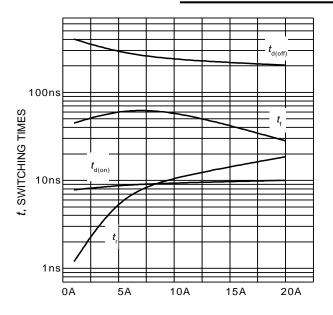
Figure 7. Typical transfer characteristic (V_{CE}=20V)



 $T_{\rm J}$, JUNCTION TEMPERATURE Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature $(V_{\rm GE}=15\rm V)$







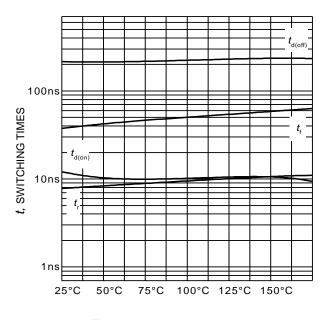
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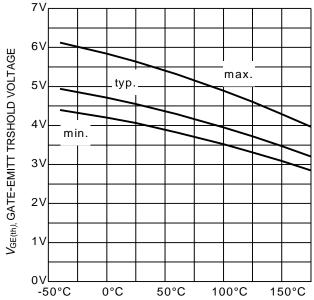
 I_C , COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current (inductive load, T_J =175°C, V_{CE} = 400V, V_{GE} = 0/15V, r_G = 23 Ω , Dynamic test circuit in Figure E)

 $R_{\rm G}$, gate resistor

Figure 10. Typical switching times as a function of gate resistor (inductive load, T_J = 175°C, V_{CE} = 400V, V_{GE} = 0/15V, I_C = 10A, Dynamic test circuit in Figure E)





 $T_{
m J}$, JUNCTION TEMPERATURE

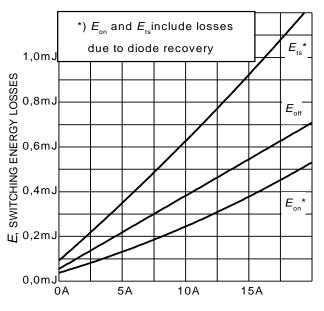
Figure 11. Typical switching times as a function of junction temperature (inductive load, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/15V, $I_{\rm C}$ = 10A, $r_{\rm G}$ =23 Ω , Dynamic test circuit in Figure E)

 $T_{
m J}$, JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature $(I_C = 0.3\text{mA})$







 $I_{\rm C}$, COLLECTOR CURRENT

Figure 13. Typical switching energy losses as a function of collector current (inductive load, T_J = 175°C, V_{CE} = 400V, V_{GE} = 0/15V, r_G = 23 Ω , Dynamic test circuit in Figure E)

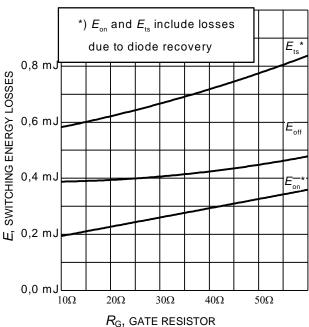


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, $T_J = 175$ °C, $V_{CE} = 400$ V, $V_{GE} = 0/15$ V, $I_C = 10$ A, Dynamic test circuit in Figure E)

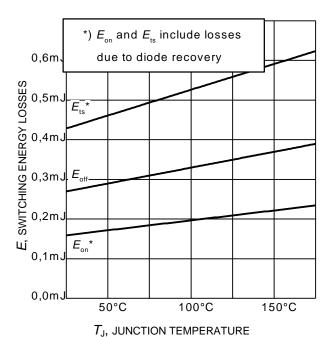
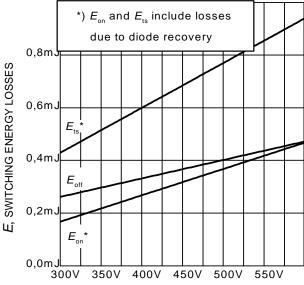


Figure 15. Typical switching energy losses as a function of junction temperature

(inductive load, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/15V, $I_{\rm C}$ = 10A, $r_{\rm G}$ = 23 Ω , Dynamic test circuit in Figure E)



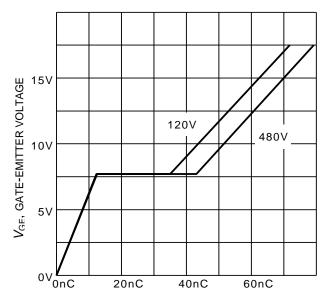
 $V_{\it CE}$, COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load, T_J = 175°C, V_{GE} = 0/15V, I_C = 10A, r_G = 23 Ω , Dynamic test circuit in Figure E)







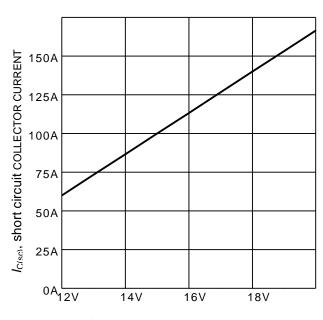
100pF 100pF 0V 10V 20V

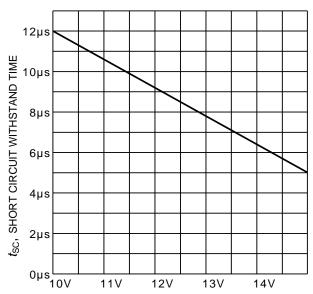
Q_{GE}, GATE CHARGE

Figure 17. Typical gate charge $(I_C=10 \text{ A})$

 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f=1 \text{ MHz})$





 $V_{\rm GE}$, gate-emittetr voltage

Figure 19. Typical short circuit collector current as a function of gate-emitter voltage $(V_{CE} \le 400 \text{V}, \ T_{j} \le 150 ^{\circ}\text{C})$

 $V_{\rm GE}$, gate-emitetr voltage

Figure 20. Short circuit withstand time as a function of gate-emitter voltage (V_{CE} =400V, start at T_{J} =25°C, T_{Jmax} <150°C)





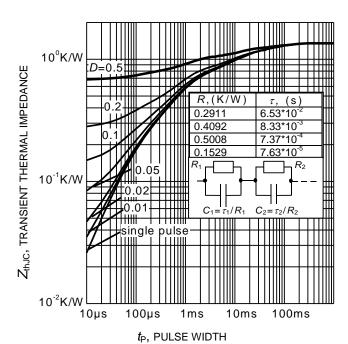
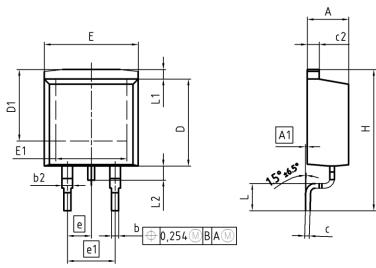
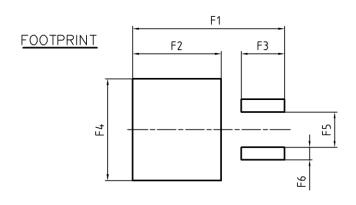


Figure 21. IGBT transient thermal impedance $(D = t_p / T)$







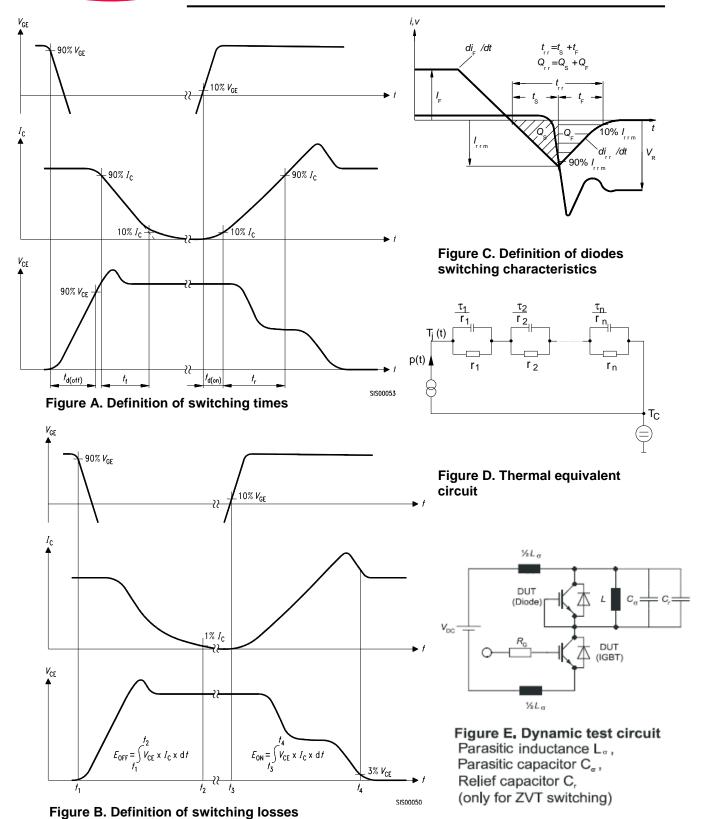


DIM	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	0.00	0.25	0.000	0.010	
Ь	0.65	0.85	0.026	0.033	
ь2	0.95	1.15	0.037	0.045	
С	0.33	0.65	0.013	0.026	
c2	1.17	1.40	0.046	0.055	
D	8.51	9.45	0.335	0.372	
D1	7.10	7.90	0.280	0.311	
E	9.80	10.31	0.386	0.406	
E1	6.50	8.60	0.256	0.339	
е	2.5	54	0.1	100	
e1	5.0)8	0.2	200	
N		2		2	
Н	14.61	15.88	0.575	0.625	
L	2.29	3.00	0.090	0.118	
L1	0.70	1.60	0.028	0.063	
L2	1.00	1.78	0.039	0.070	
F1	16.05	16.25	0.632	0.640	
F2	9.30	9.50	0.366	0.374	
F3	4.50	4.70	0.177	0.185	
F4	10.70	10.90	0.421	0.429	
F5	3.65	3.85	0.144	0.152	
F6	1.25	1.45	0.049	0.057	

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